

Vishay General Semiconductor

# Surface-Mount TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier





Models Available

PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	3 A		
V <sub>RRM</sub>	60 V		
I <sub>FSM</sub>	60 A		
V <sub>F</sub> at I <sub>F</sub> = 3 A (125 °C)	0.47 V		
T <sub>J</sub> max.	175 °C		
Package	SlimSMAW (DO-221AD)		
Circuit configuration	Single		

### FEATURES

- Low-profile package
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



COMPLIANT

AUTOMOTIVE

- AEC-Q101 qualified available
  Automotive ordering code: base P/NHM3
- Compatible to SOD-128 package case outline
  FREE
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

## **MECHANICAL DATA**

**Case:** SlimSMAW (DO-221AD) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test **Polarity:** color band denotes cathode end

MAXIMUM RATINGS	(T <sub>A</sub> = 25 °C unless otherwise noted)	

PARAMETER	SYMBOL	VSS8D3M6	UNIT	
Device marking code		V3M6		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V	
Maximum average forward rectified current (fig.1)	I <sub>F(AV)</sub> <sup>(1)</sup>	3		
Maximum average forward rectilied current (lig. r)	I <sub>F(AV)</sub> <sup>(2)</sup>	2.5	— A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	60	А	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +175	°C	
Storage temperature range	T <sub>STG</sub>	-55 to +175	C	

Notes

(1) Mounted on 30 mm x 30 mm AL PCB pad area

<sup>(2)</sup> Free air, mounted on recommended copper pad area

<sup>(3)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{0JA}$ 





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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	TEST CO	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1.5 A		– V <sub>F</sub> <sup>(1)</sup>	0.49	-	V
	$I_F = 3 A$			0.54	0.62	
	I <sub>F</sub> = 1.5 A	– T <sub>A</sub> = 125 °C		0.39	-	
	I <sub>F</sub> = 3 A			0.47	0.54	
Reverse current	V <sub>R</sub> = 60 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	-	0.3	mA
	$v_{\rm R} = 00 v$			2	6	
Typical junction capacitance	4.0 V, 1 MH	4.0 V, 1 MHz		500	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise specified)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Typical thermal resistance	R <sub>0JA</sub> <sup>(1)(2)</sup>	120	150	°C/W
	R <sub>0JM</sub> <sup>(3)</sup>	12	15	C/W

#### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
VSS8D3M6-M3/H	0.033	Н	3500	7" diameter plastic tape and reel		
VSS8D3M6-M3/I	0.033	I	14 000	13" diameter plastic tape and reel		
VSS8D3M6HM3/H <sup>(1)</sup>	0.033	Н	3500	7" diameter plastic tape and reel		
VSS8D3M6HM3/I <sup>(1)</sup>	0.033	I	14 000	13" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified



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## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)

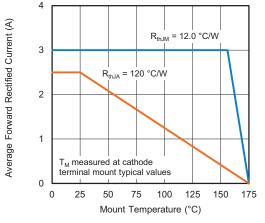


Fig. 1 - Maximum Forward Current Derating Curve

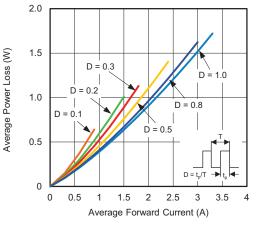


Fig. 2 - Forward Power Loss Characteristics

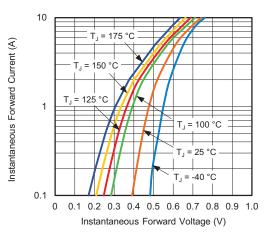


Fig. 3 - Typical Instantaneous Forward Characteristics

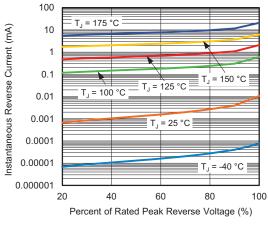


Fig. 4 - Typical Reverse Leakage Characteristics

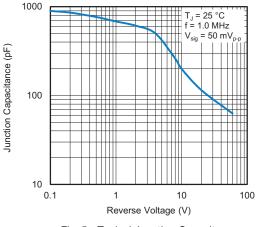


Fig. 5 - Typical Junction Capacitance

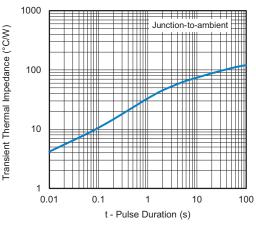


Fig. 6 - Typical Transient Thermal Impedance

Revision: 21-Jan-2019

3

Document Number: 87412

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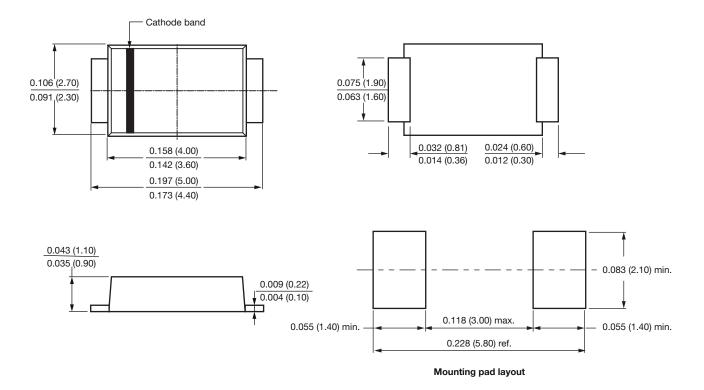


# VSS8D3M6

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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

SlimSMAW (DO-221AD)





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